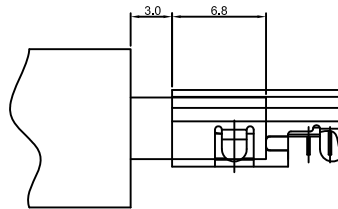
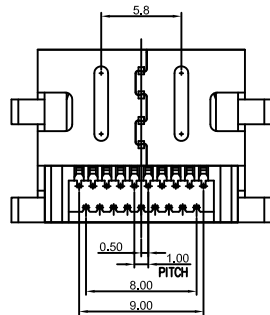
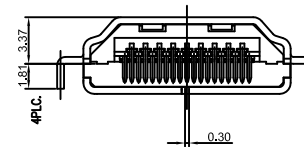
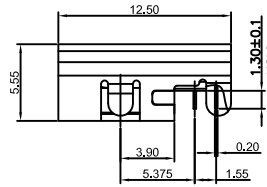
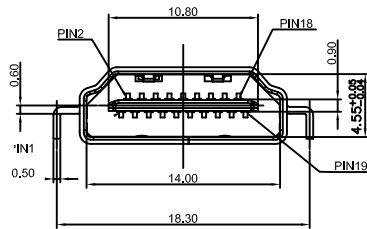



NOTE:
 1.MATERIAL:
 HOUSING: THERMOPLASTIC HIGH TEMP WITH 30%GF,UL94V-0.
 CONTACT: BRASS T=0.20mm
 SHELL: BRASS T=0.50mm
 MYLAR: KAPTON TAPE
 2.FINISH:
 CONTACT: GOLD PLATING ON CONTACT AREA,
 MATTE MATTE TIN PLATING ON SOLDERTAILS
 100u" MIN. NICKEL UNDERPLATING OVERALL.
 SHELL: 40u"MIN. NICKEL PLATING OVERALL.

RECOMMENDED P.C.B LAYOUT(THICKNESS=1.2mm)

(COMPONENT SIDE)TOLERANCES±0.05mm



NO 번호	DATE 변경일자	DESCRIPTION OF REVISION 변경내용	DESIGNED 작성	CHECKED 검토	APPROVED 승인	MATERIAL 재질		SPECIFICATION 규격		FINISH 표면처리	QUANTITY 수량	SCALE 척도 UNIT 단위 / mm	
						DESIGNED 작성	CHECKED 검토	APPROVAL 승인	DRAWING NUMBER 도번				
			김도현	박재규	최국환	PART NAME 부품명	HY-05H8	 한유안 ELECTRONICS CO.,LTD					
						MODEL NAME 제품명	HY-05H8						
DESIGNED 작성						상현전자 주식회사		3RD ANGLE PROJ	HANYONES TECH CO.,LTD		FILE. NO.		